

5.0Amp Fast Recovery Silicon Rectifiers
Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Open Junction chip
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed
250°C/10 seconds at terminals

Mechanical Data

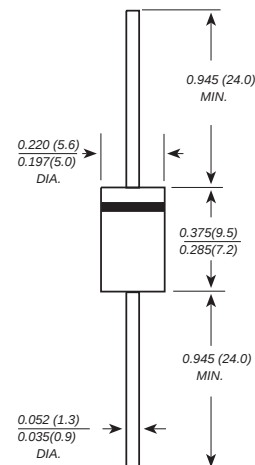
Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750,Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0345 ounce, 0.98 grams

DO-201AD(DO-27)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	FR501	FR502	FR503	FR504	FR505	FR506	FR507	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at T _L =100°C	I _(AV)	5.0							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	175.0							A
Maximum instantaneous forward voltage at 5.0A	V _F	1.30							V
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =125°C	I _R	10.0 500							μA
Maxinum reverse recovery time(Note 1)	T _{rr}	150				250	500		ns
Typical junction capacitance (Note2)	C _J	80.0							pF
Typical thermal resistance	R _{qJA}	40.0							°C/W
Operating junction and storage temperature range	T _J ,T _{STG}	-55 to +150							°C

Note: 1.Reverse recovery time test condition: $I_F=0.5\text{A}$ $I_R=1.0\text{A}$ $I_{rr}=0.25\text{A}$
2.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

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Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

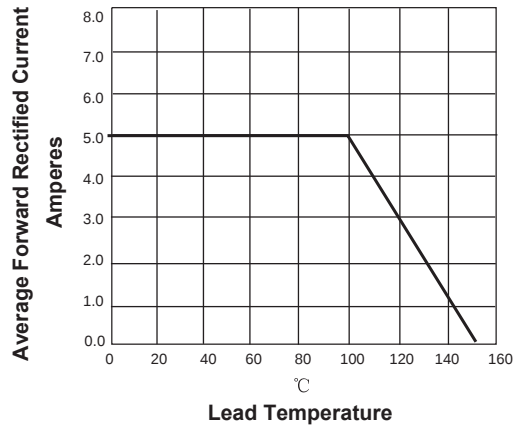


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER LEG

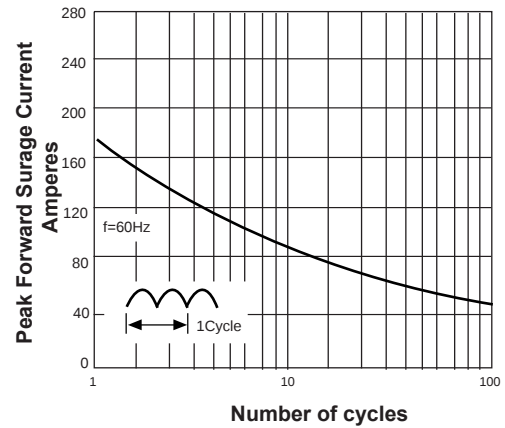


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

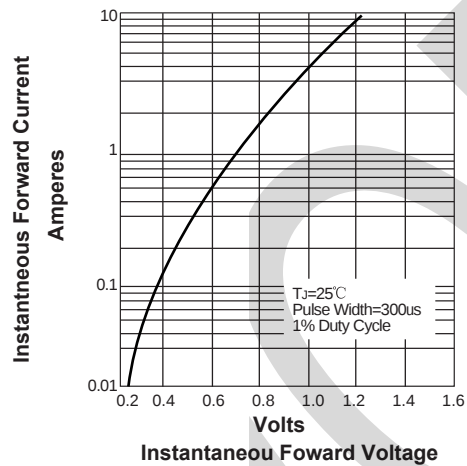
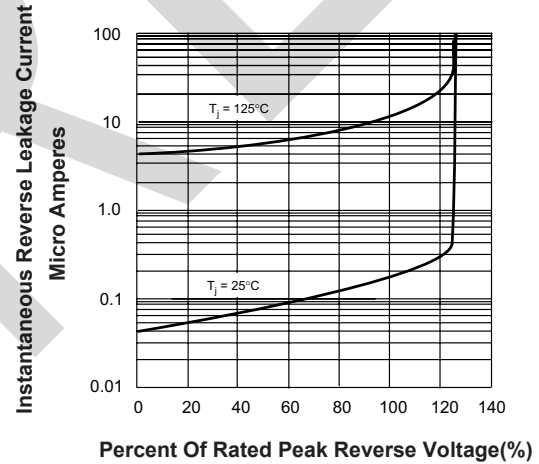
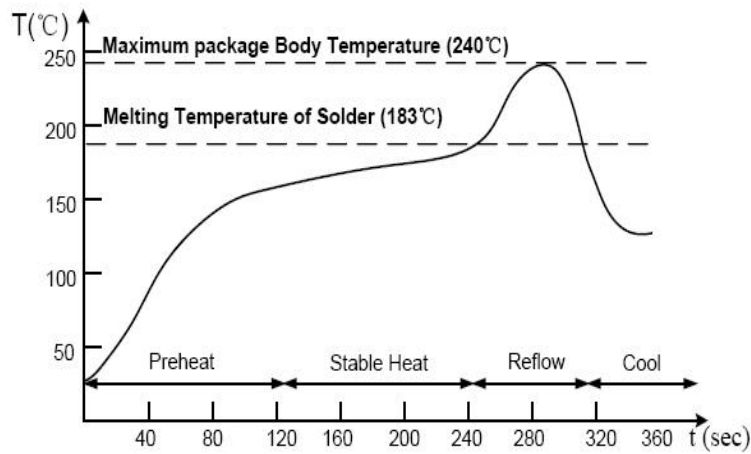


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



Suggested Soldering Temperature Profile



Note

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Marking Information

Cathode



Anode

① Product model : FR501~FR507

② PDC information:

Y X WW

WW: Week code(01 to 53)

X: Internal identification code

Y: Year code(ex:0=2020)